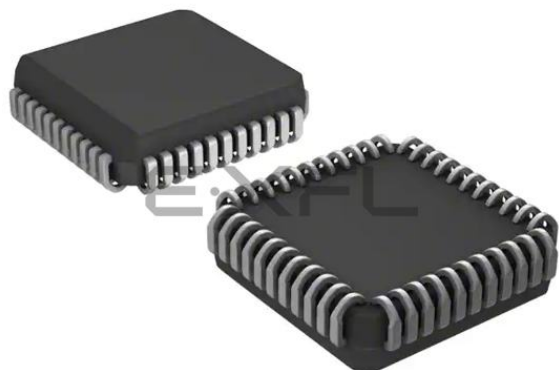




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### Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

|                                 |                                                                                                                                                                   |
|---------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Status                  | Obsolete                                                                                                                                                          |
| Programmable Type               | In System Programmable                                                                                                                                            |
| Delay Time tpd(1) Max           | 7.5 ns                                                                                                                                                            |
| Voltage Supply - Internal       | 3V ~ 3.6V                                                                                                                                                         |
| Number of Logic Elements/Blocks | -                                                                                                                                                                 |
| Number of Macrocells            | 64                                                                                                                                                                |
| Number of Gates                 | -                                                                                                                                                                 |
| Number of I/O                   | 32                                                                                                                                                                |
| Operating Temperature           | 0°C ~ 70°C (TA)                                                                                                                                                   |
| Mounting Type                   | Surface Mount                                                                                                                                                     |
| Package / Case                  | 44-LCC (J-Lead)                                                                                                                                                   |
| Supplier Device Package         | 44-PLCC (16.59x16.59)                                                                                                                                             |
| Purchase URL                    | <a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/m4a3-64-32-7jc">https://www.e-xfl.com/product-detail/lattice-semiconductor/m4a3-64-32-7jc</a> |

The ispMACH 4A family offers 20 density-I/O combinations in Thin Quad Flat Pack (TQFP), Plastic Quad Flat Pack (PQFP), Plastic Leaded Chip Carrier (PLCC), Ball Grid Array (BGA), fine-pitch BGA (fpBGA), and chip-array BGA (caBGA) packages ranging from 44 to 388 pins (Table 3). It also offers I/O safety features for mixed-voltage designs so that the 3.3-V devices can accept 5-V inputs, and 5-V devices do not overdrive 3.3-V inputs. Additional features include Bus-Friendly inputs and I/Os, a programmable power-down mode for extra power savings and individual output slew rate control for the highest speed transition or for the lowest noise transition.

**Table 3. ispMACH 4A Package and I/O Options (Number of I/Os and dedicated inputs in Table)**

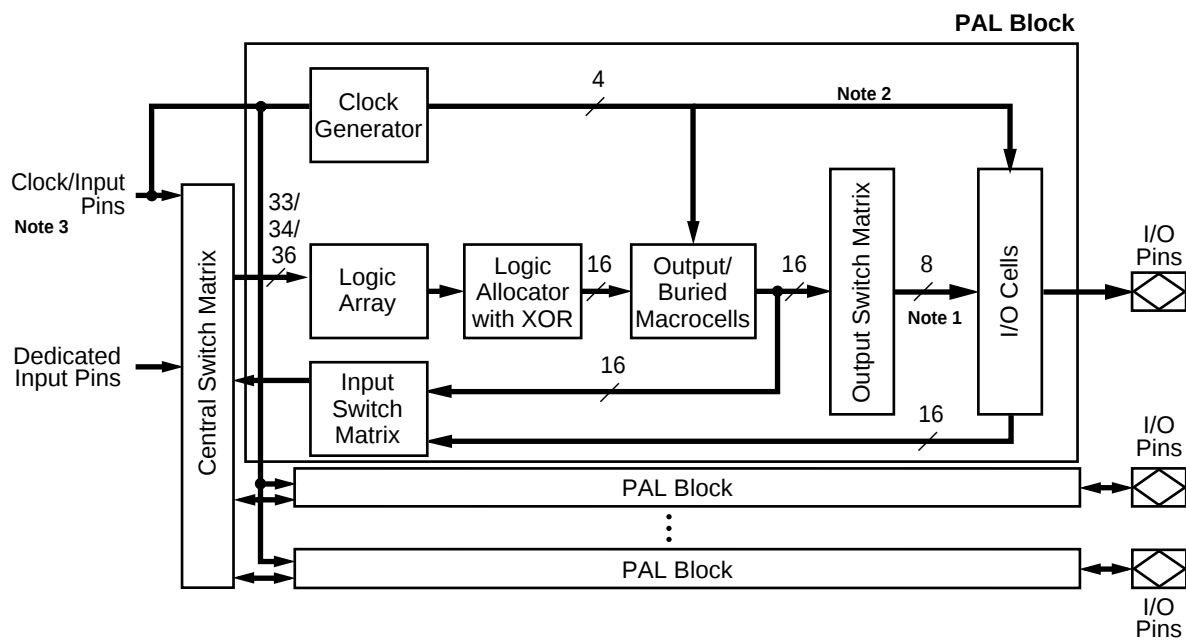
| 3.3 V Devices  |         |         |         |          |          |             |          |          |
|----------------|---------|---------|---------|----------|----------|-------------|----------|----------|
| Package        | M4A3-32 | M4A3-64 | M4A3-96 | M4A3-128 | M4A3-192 | M4A3-256    | M4A3-384 | M4A3-512 |
| 44-pin PLCC    | 32+2    | 32+2    |         |          |          |             |          |          |
| 44-pin TQFP    | 32+2    | 32+2    |         |          |          |             |          |          |
| 48-pin TQFP    | 32+2    | 32+2    |         |          |          |             |          |          |
| 100-pin TQFP   |         | 64+6    | 48+8    | 64+6     |          |             |          |          |
| 100-pin PQFP   |         |         |         | 64+6     |          |             |          |          |
| 100-ball caBGA |         |         |         | 64+6     |          |             |          |          |
| 144-pin TQFP   |         |         |         |          | 96+16    |             |          |          |
| 144-ball fpBGA |         |         |         |          | 96+16    |             |          |          |
| 208-pin PQFP   |         |         |         |          |          | 128+14, 160 | 160      | 160      |
| 256-ball fpBGA |         |         |         |          |          | 128+14, 192 | 192      | 192      |
| 256-ball BGA   |         |         |         |          |          | 128+14      | 192      |          |
| 388-ball fpBGA |         |         |         |          |          |             |          | 256      |

| 5 V Devices  |         |         |         |          |          |          |
|--------------|---------|---------|---------|----------|----------|----------|
| Package      | M4A5-32 | M4A5-64 | M4A5-96 | M4A5-128 | M4A5-192 | M4A5-256 |
| 44-pin PLCC  | 32+2    | 32+2    |         |          |          |          |
| 44-pin TQFP  | 32+2    | 32+2    |         |          |          |          |
| 48-pin TQFP  | 32+2    | 32+2    |         |          |          |          |
| 100-pin TQFP |         |         | 48+8    | 64+6     |          |          |
| 100-pin PQFP |         |         |         | 64+6     |          |          |
| 144-pin TQFP |         |         |         |          | 96+16    |          |
| 208-pin PQFP |         |         |         |          |          | 128+14   |

## FUNCTIONAL DESCRIPTION

The fundamental architecture of ispMACH 4A devices (Figure 1) consists of multiple, optimized PAL<sup>®</sup> blocks interconnected by a central switch matrix. The central switch matrix allows communication between PAL blocks and routes inputs to the PAL blocks. Together, the PAL blocks and central switch matrix allow the logic designer to create large designs in a single device instead of having to use multiple devices.

The key to being able to make effective use of these devices lies in the interconnect schemes. In the ispMACH 4A architecture, the macrocells are flexibly coupled to the product terms through the logic allocator, and the I/O pins are flexibly coupled to the macrocells due to the output switch matrix. In addition, more input routing options are provided by the input switch matrix. These resources provide the flexibility needed to fit designs efficiently.

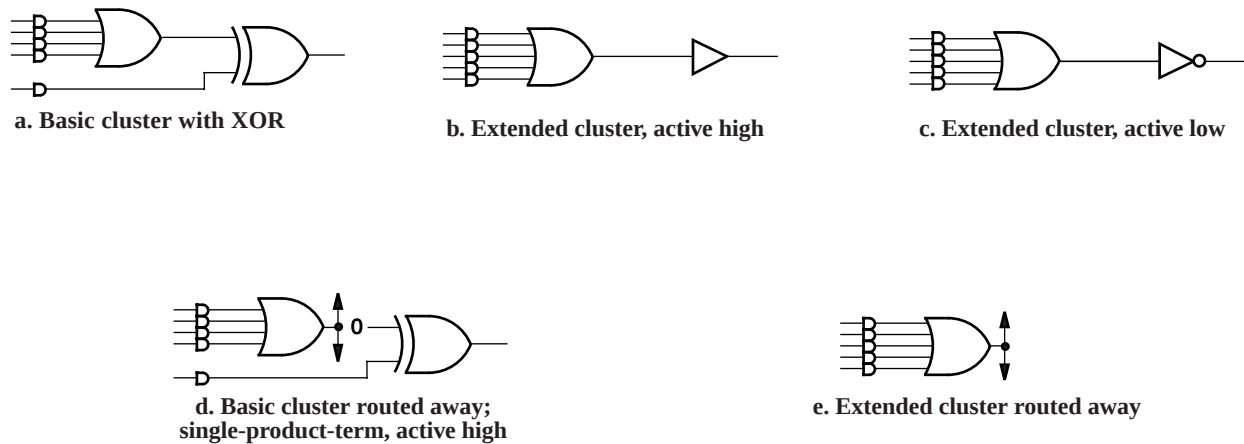


17466G-001

**Figure 1. ispMACH 4A Block Diagram and PAL Block Structure**

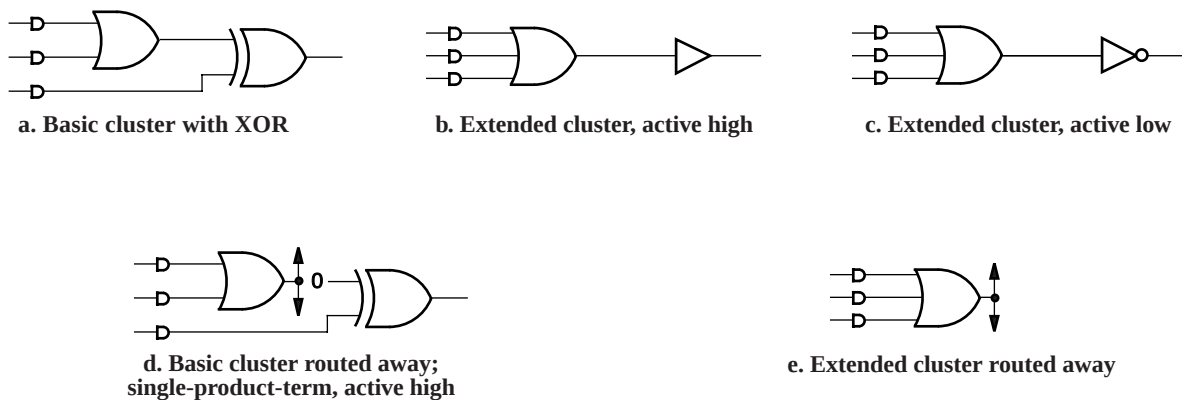
### Notes:

1. 16 for ispMACH 4A devices with 1:1 macrocell-I/O cell ratio (see next page).
2. Block clocks do not go to I/O cells in M4A(3,5)-32/32.
3. M4A(3,5)-192, M4A(3,5)-256, M4A3-384, and M4A3-512 have dedicated clock pins which cannot be used as inputs and do not connect to the central switch matrix.



17466G-007

**Figure 3. Logic Allocator Configurations: Synchronous Mode**



17466G-008

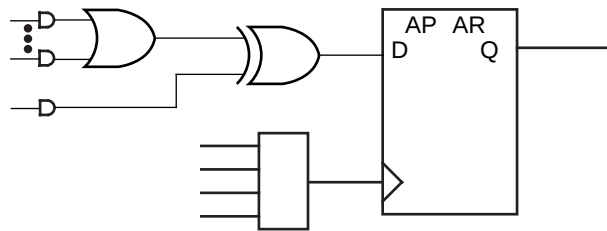
**Figure 4. Logic Allocator Configurations: Asynchronous Mode**

Note that the configuration of the logic allocator has absolutely no impact on the speed of the signal. All configurations have the same delay. This means that designers do not have to decide between optimizing resources or speed; both can be optimized.

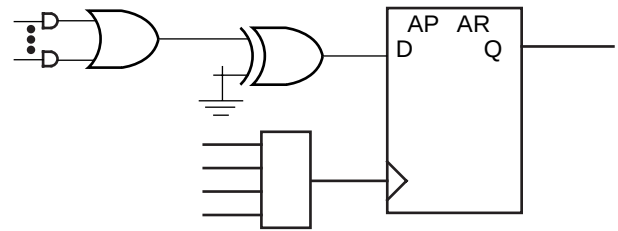
If not used in the cluster, the extra product term can act in conjunction with the basic cluster to provide XOR logic for such functions as data comparison, or it can work with the D-,T-type flip-flop to provide for J-K, and S-R register operation. In addition, if the basic cluster is routed to another macrocell, the extra product term is still available for logic. In this case, the first XOR input will be a logic 0. This circuit has the flexibility to route product terms elsewhere without giving up the use of the macrocell.

Product term clusters do not “wrap” around a PAL block. This means that the macrocells at the ends of the block have fewer product terms available.

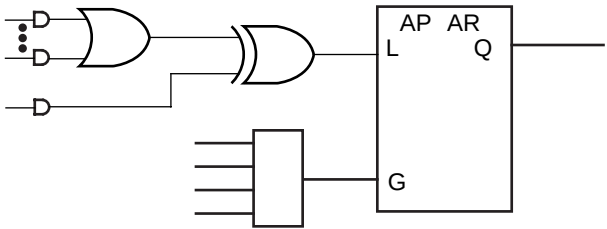
The flip-flop can be configured as a D-type or T-type latch. J-K or S-R registers can be synthesized. The primary flip-flop configurations are shown in Figure 6, although others are possible. Flip-flop functionality is defined in Table 8. Note that a J-K latch is inadvisable as it will cause oscillation if both J and K inputs are HIGH.



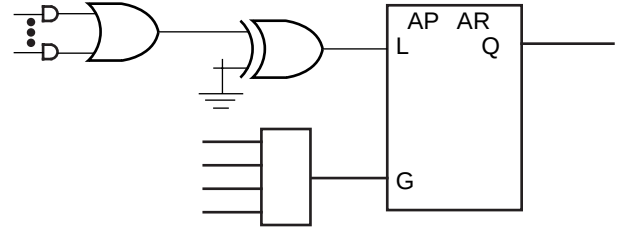
a. D-type with XOR



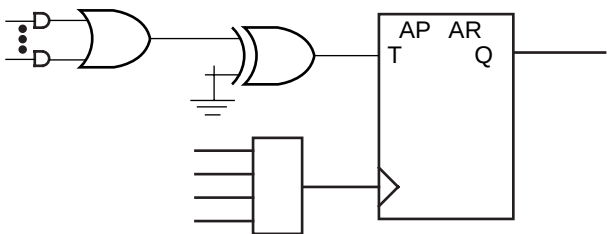
b. D-type with programmable D polarity



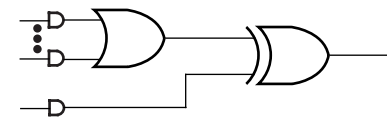
c. Latch with XOR



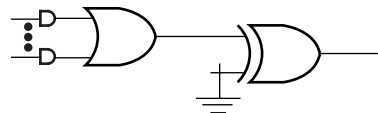
d. Latch with programmable D polarity



e. T-type with programmable T polarity



f. Combinatorial with XOR

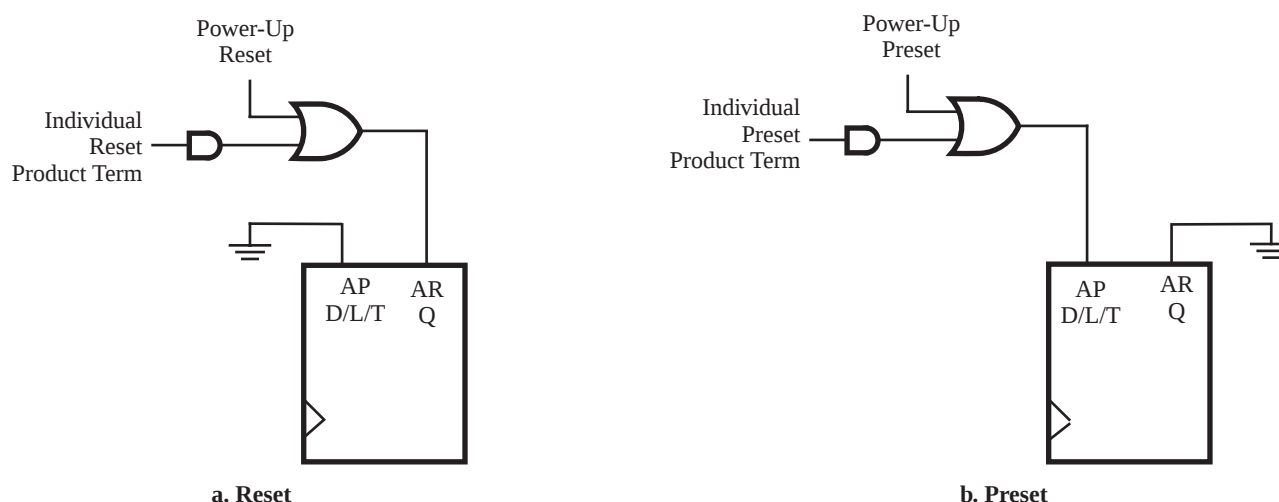


g. Combinatorial with programmable polarity

Figure 6. Primary Macrocell Configurations

17466G-011

A reset/preset swapping feature in each macrocell allows for reset and preset to be exchanged, providing flexibility. In asynchronous mode (Figure 8), a single individual product term is provided for initialization. It can be selected to control reset or preset.



17466G-014

17466G-015

**Figure 8. Asynchronous Mode Initialization Configurations**

Note that the reset/preset swapping selection feature effects power-up reset as well. The initialization functionality of the flip-flops is illustrated in Table 9. The macrocell sends its data to the output switch matrix and the input switch matrix. The output switch matrix can route this data to an output if so desired. The input switch matrix can send the signal back to the central switch matrix as feedback.

**Table 9. Asynchronous Reset/Preset Operation**

| AR | AP | CLK/LE <sup>1</sup> | Q+          |
|----|----|---------------------|-------------|
| 0  | 0  | X                   | See Table 8 |
| 0  | 1  | X                   | 1           |
| 1  | 0  | X                   | 0           |
| 1  | 1  | X                   | 0           |

**Note:**

- Transparent latch is unaffected by AR, AP

## Output Switch Matrix

The output switch matrix allows macrocells to be connected to any of several I/O cells within a PAL block. This provides high flexibility in determining pinout and allows design changes to occur without effecting pinout.

In ispMACH 4A devices with 2:1 Macrocell-I/O cell ratio, each PAL block has twice as many macrocells as I/O cells. The ispMACH 4A output switch matrix allows for half of the macrocells to drive I/O cells within a PAL block, in combinations according to Figure 9. Each I/O cell can choose from eight macrocells; each macrocell has a choice of four I/O cells. The ispMACH 4A devices with 1:1 Macrocell-I/O cell ratio allow each macrocell to drive one of eight I/O cells (Figure 9).

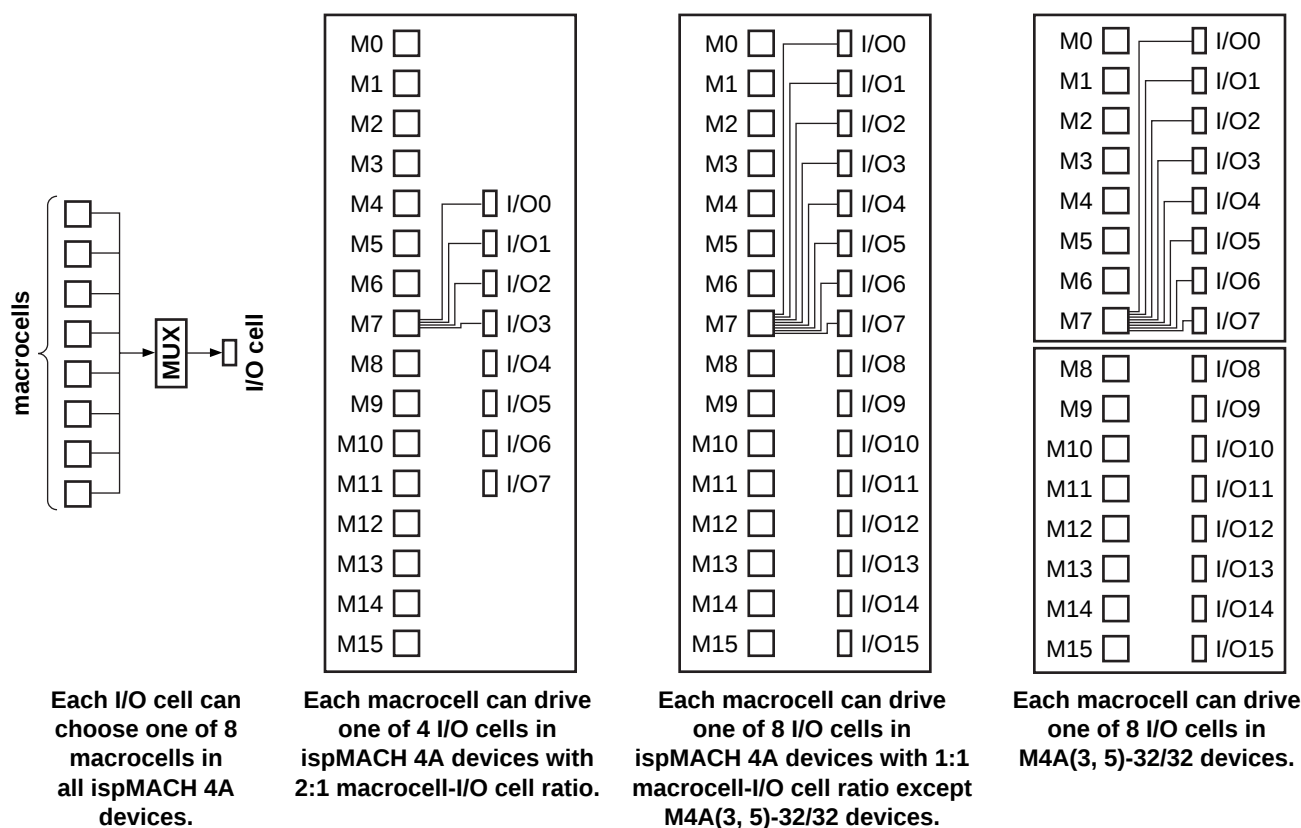


Figure 9. ispMACH 4A Output Switch Matrix

Table 10. Output Switch Matrix Combinations for ispMACH 4A Devices with 2:1 Macrocell-I/O Cell Ratio

| Macrocell | Routeable to I/O Cells |
|-----------|------------------------|
| M0, M1    | I/O0, I/O5, I/O6, I/O7 |
| M2, M3    | I/O0, I/O1, I/O6, I/O7 |
| M4, M5    | I/O0, I/O1, I/O2, I/O7 |
| M6, M7    | I/O0, I/O1, I/O2, I/O3 |
| M8, M9    | I/O1, I/O2, I/O3, I/O4 |
| M10, M11  | I/O2, I/O3, I/O4, I/O5 |

**Table 10. Output Switch Matrix Combinations for ispMACH 4A Devices with 2:1 Macrocell-I/O Cell Ratio**

| Macrocell | Routable to I/O Cells  |
|-----------|------------------------|
| M12, M13  | I/O3, I/O4, I/O5, I/O6 |
| M14, M15  | I/O4, I/O5, I/O6, I/O7 |

| I/O Cell | Available Macrocells                 |
|----------|--------------------------------------|
| I/O0     | M0, M1, M2, M3, M4, M5, M6, M7       |
| I/O1     | M2, M3, M4, M5, M6, M7, M8, M9       |
| I/O2     | M4, M5, M6, M7, M8, M9, M10, M11     |
| I/O3     | M6, M7, M8, M9, M10, M11, M12, M13   |
| I/O4     | M8, M9, M10, M11, M12, M13, M14, M15 |
| I/O5     | M0, M1, M10, M11, M12, M13, M14, M15 |
| I/O6     | M0, M1, M2, M3, M12, M13, M14, M15   |
| I/O7     | M0, M1, M2, M3, M4, M5, M14, M15     |

**Table 11. Output Switch Matrix Combinations for M4A3-256/160 and M4A3-256/192**

| Macrocell | Routable to I/O Cells |      |       |       |       |       |       |       |
|-----------|-----------------------|------|-------|-------|-------|-------|-------|-------|
| M0        | I/O0                  | I/O1 | I/O2  | I/O3  | I/O4  | I/O5  | I/O6  | I/O7  |
| M1        | I/O0                  | I/O1 | I/O2  | I/O3  | I/O4  | I/O5  | I/O6  | I/O7  |
| M2        | I/O0                  | I/O1 | I/O2  | I/O3  | I/O4  | I/O5  | I/O6  | I/O7  |
| M3        | I/O0                  | I/O1 | I/O2  | I/O3  | I/O4  | I/O5  | I/O6  | I/O7  |
| M4        | I/O0                  | I/O1 | I/O2  | I/O3  | I/O4  | I/O5  | I/O6  | I/O7  |
| M5        | I/O0                  | I/O1 | I/O2  | I/O3  | I/O4  | I/O5  | I/O6  | I/O7  |
| M6        | I/O0                  | I/O1 | I/O2  | I/O3  | I/O4  | I/O5  | I/O6  | I/O7  |
| M7        | I/O0                  | I/O1 | I/O2  | I/O3  | I/O4  | I/O5  | I/O6  | I/O7  |
| M8        | I/O8                  | I/O9 | I/O10 | I/O11 | I/O12 | I/O13 | I/O14 | I/O15 |
| M9        | I/O8                  | I/O9 | I/O10 | I/O11 | I/O12 | I/O13 | I/O14 | I/O15 |
| M10       | I/O8                  | I/O9 | I/O10 | I/O11 | I/O12 | I/O13 | I/O14 | I/O15 |
| M11       | I/O8                  | I/O9 | I/O10 | I/O11 | I/O12 | I/O13 | I/O14 | I/O15 |
| M12       | I/O8                  | I/O9 | I/O10 | I/O11 | I/O12 | I/O13 | I/O14 | I/O15 |
| M13       | I/O8                  | I/O9 | I/O10 | I/O11 | I/O12 | I/O13 | I/O14 | I/O15 |
| M14       | I/O8                  | I/O9 | I/O10 | I/O11 | I/O12 | I/O13 | I/O14 | I/O15 |
| M15       | I/O8                  | I/O9 | I/O10 | I/O11 | I/O12 | I/O13 | I/O14 | I/O15 |

| I/O Cell | Available Macrocells |    |    |    |    |    |    |    |
|----------|----------------------|----|----|----|----|----|----|----|
| I/O0     | M0                   | M1 | M2 | M3 | M4 | M5 | M6 | M7 |
| I/O1     | M0                   | M1 | M2 | M3 | M4 | M5 | M6 | M7 |
| I/O2     | M0                   | M1 | M2 | M3 | M4 | M5 | M6 | M7 |
| I/O3     | M0                   | M1 | M2 | M3 | M4 | M5 | M6 | M7 |
| I/O4     | M0                   | M1 | M2 | M3 | M4 | M5 | M6 | M7 |
| I/O5     | M0                   | M1 | M2 | M3 | M4 | M5 | M6 | M7 |
| I/O6     | M0                   | M1 | M2 | M3 | M4 | M5 | M6 | M7 |
| I/O7     | M0                   | M1 | M2 | M3 | M4 | M5 | M6 | M7 |

## IEEE 1149.1-COMPLIANT BOUNDARY SCAN TESTABILITY

All ispMACH 4A devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more complete board-level testing.

## IEEE 1149.1-COMPLIANT IN-SYSTEM PROGRAMMING

Programming devices in-system provides a number of significant benefits including: rapid prototyping, lower inventory levels, higher quality, and the ability to make in-field modifications. All ispMACH 4A devices provide In-System Programming (ISP) capability through their Boundary ScanTest Access Ports. This capability has been implemented in a manner that ensures that the port remains compliant to the IEEE 1149.1 standard. By using IEEE 1149.1 as the communication interface through which ISP is achieved, customers get the benefit of a standard, well-defined interface.

ispMACH 4A devices can be programmed across the commercial temperature and voltage range. The PC-based ispVM™ software facilitates in-system programming of ispMACH 4A devices. ispVM takes the JEDEC file output produced by the design implementation software, along with information about the JTAG chain, and creates a set of vectors that are used to drive the JTAG chain. ispVM software can use these vectors to drive a JTAG chain via the parallel port of a PC. Alternatively, ispVM software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispMACH 4A devices during the testing of a circuit board.

## PCI COMPLIANT

ispMACH 4A devices in the -5/-55/-6/-65/-7/-10/-12 speed grades are compliant with the *PCI Local Bus Specification* version 2.1, published by the PCI Special Interest Group (SIG). The 5-V devices are fully PCI-compliant. The 3.3-V devices are mostly compliant but do not meet the PCI condition to clamp the inputs as they rise above  $V_{CC}$  because of their 5-V input tolerant feature.

## SAFE FOR MIXED SUPPLY VOLTAGE SYSTEM DESIGNS

Both the 3.3-V and 5-V  $V_{CC}$  ispMACH 4A devices are safe for mixed supply voltage system designs. The 5-V devices will not overdrive 3.3-V devices above the output voltage of 3.3 V, while they accept inputs from other 3.3-V devices. The 3.3-V device will accept inputs up to 5.5 V. Both the 5-V and 3.3-V versions have the same high-speed performance and provide easy-to-use mixed-voltage design capability.

## PULL UP OR BUS-FRIENDLY INPUTS AND I/Os

All ispMACH 4A devices have inputs and I/Os which feature the Bus-Friendly circuitry incorporating two inverters in series which loop back to the input. This double inversion weakly holds the input at its last driven logic state. While it is good design practice to tie unused pins to a known state, the Bus-Friendly input structure pulls pins away from the input threshold voltage where noise can cause high-frequency switching. At power-up, the Bus-Friendly latches are reset to a logic level “1.” For the circuit diagram, please refer to the document entitled *MACH Endurance Characteristics* on the Lattice Data Book CD-ROM or Lattice web site.

All ispMACH 4A devices have a programmable bit that configures all inputs and I/Os with either pull-up or Bus-Friendly characteristics. If the device is configured in pull-up mode, all inputs and I/O pins are

weakly pulled up. For the circuit diagram, please refer to the document entitled *MACH Endurance Characteristics* on the Lattice Data Book CD-ROM or Lattice web site.

## **POWER MANAGEMENT**

Each individual PAL block in ispMACH 4A devices features a programmable low-power mode, which results in power savings of up to 50%. The signal speed paths in the low-power PAL block will be slower than those in the non-low-power PAL block. This feature allows speed critical paths to run at maximum frequency while the rest of the signal paths operate in the low-power mode.

## **PROGRAMMABLE SLEW RATE**

Each ispMACH 4A device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for the higher speed transition (3 V/ns) or for the lower noise transition (1 V/ns). For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise, and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed. The slew rate is adjusted independent of power.

## **POWER-UP RESET/SET**

All flip-flops power up to a known state for predictable system initialization. If a macrocell is configured to SET on a signal from the control generator, then that macrocell will be SET during device power-up. If a macrocell is configured to RESET on a signal from the control generator or is not configured for set/reset, then that macrocell will RESET on power-up. To guarantee initialization values, the  $V_{CC}$  rise must be monotonic, and the clock must be inactive until the reset delay time has elapsed.

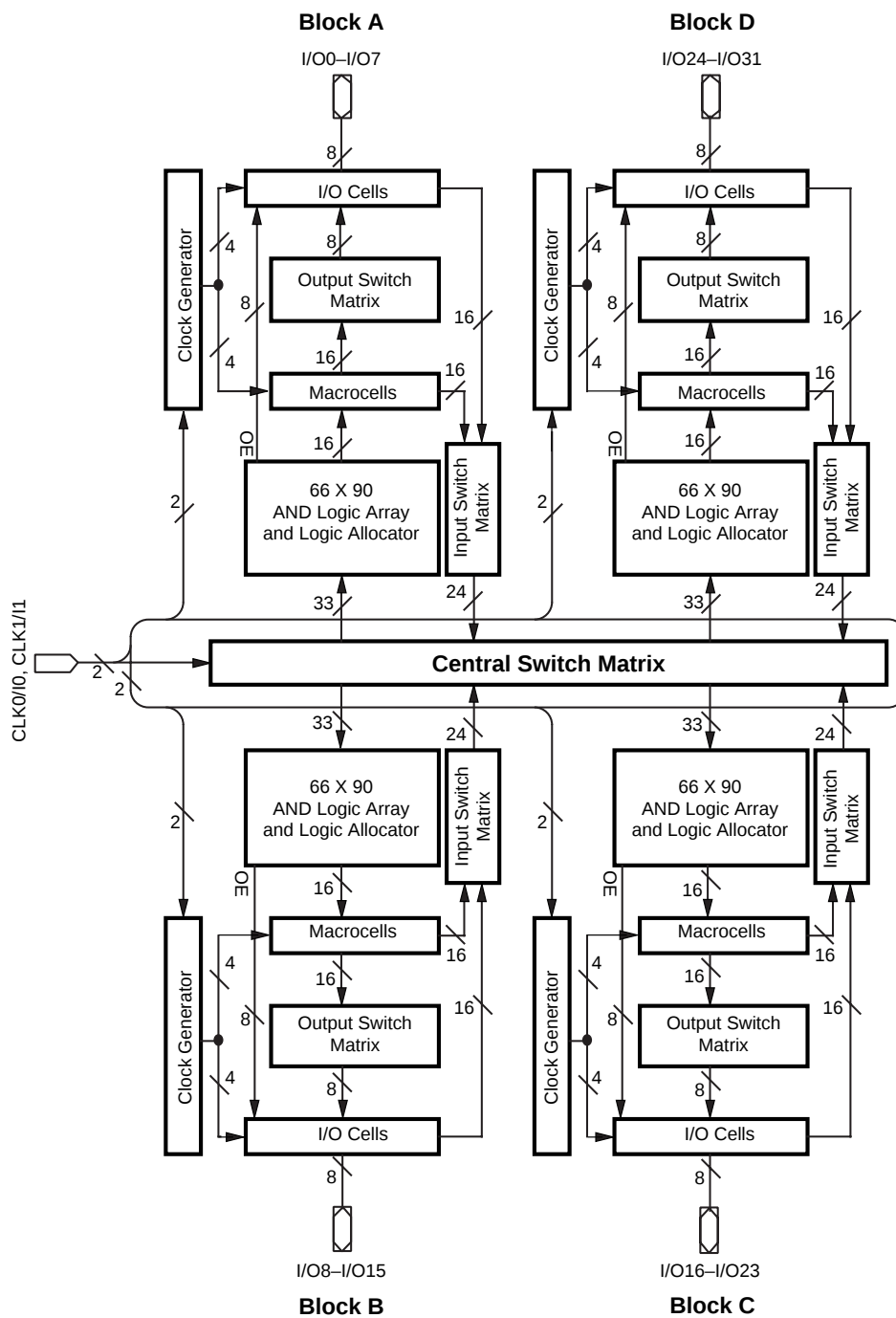
## **SECURITY BIT**

A programmable security bit is provided on the ispMACH 4A devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit defeats readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. Programming and verification are also defeated by the security bit. The bit can only be reset by erasing the entire device.

## **HOT SOCKETING**

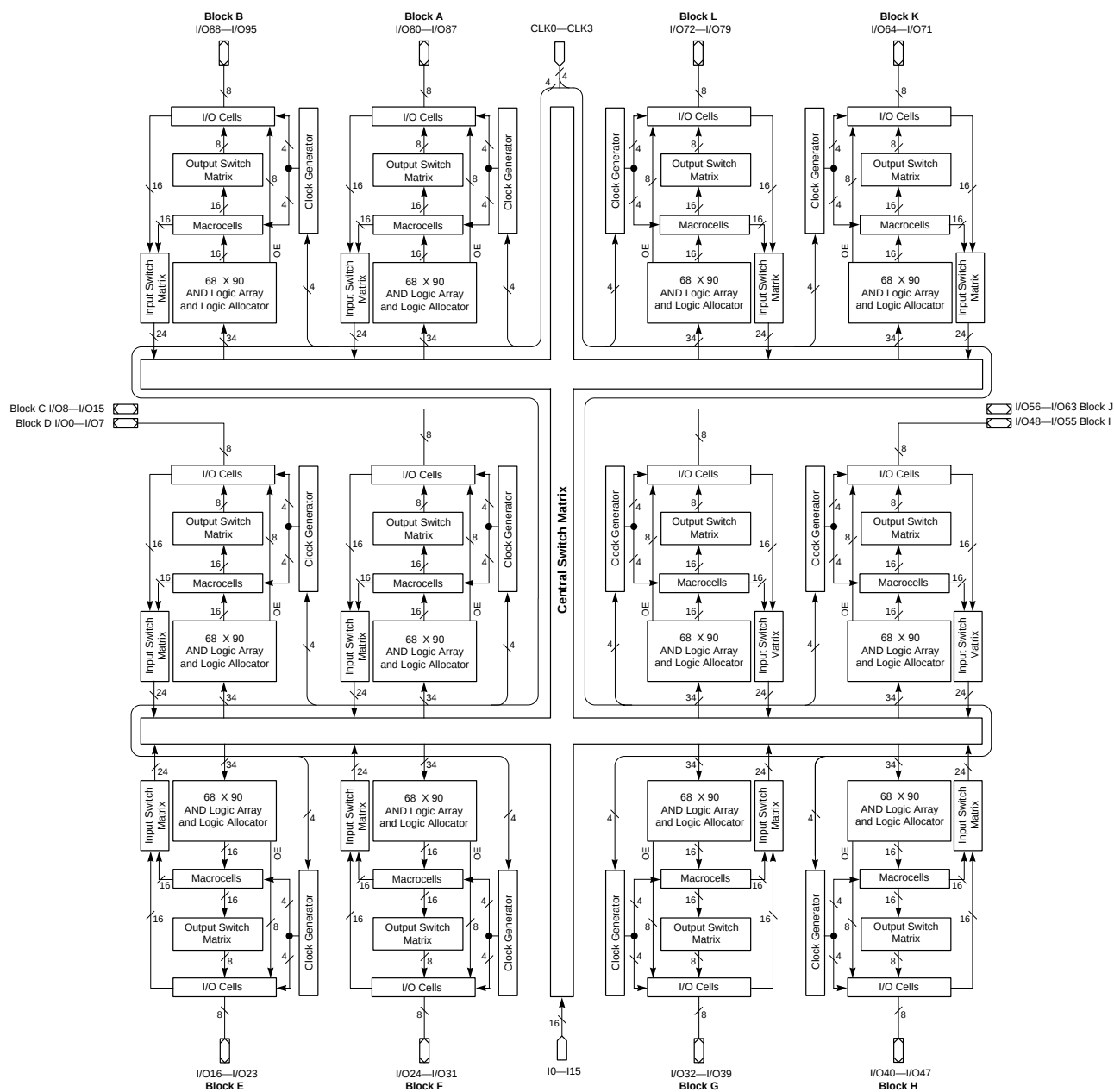
ispMACH 4A devices are well-suited for those applications that require hot socketing capability. Hot socketing a device requires that the device, when powered down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of the powered-down MACH devices be minimal on active signals.

## BLOCK DIAGRAM – M4A(3,5)-64/32



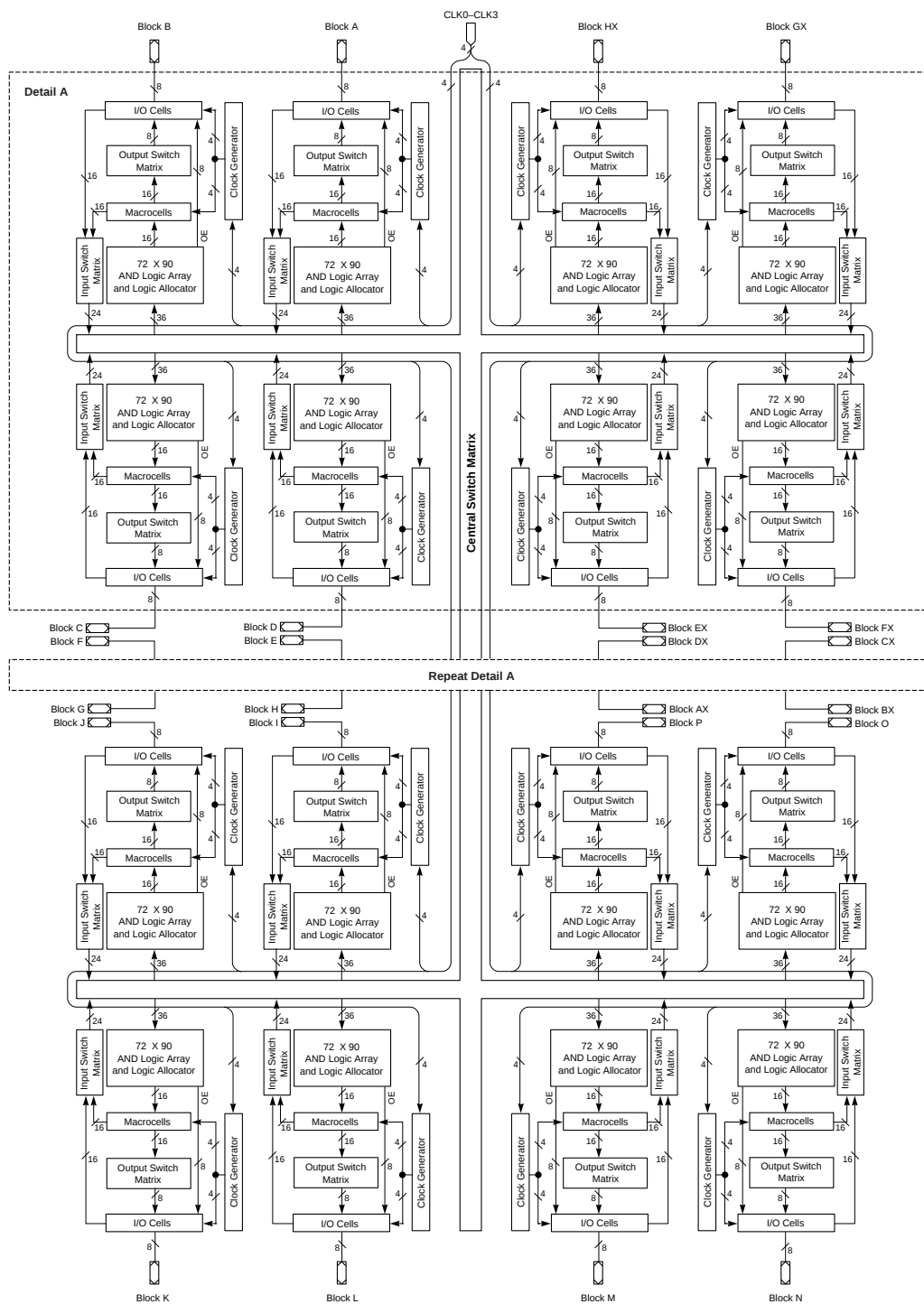
17466H-020

## BLOCK DIAGRAM – M4A(3,5)-192/96



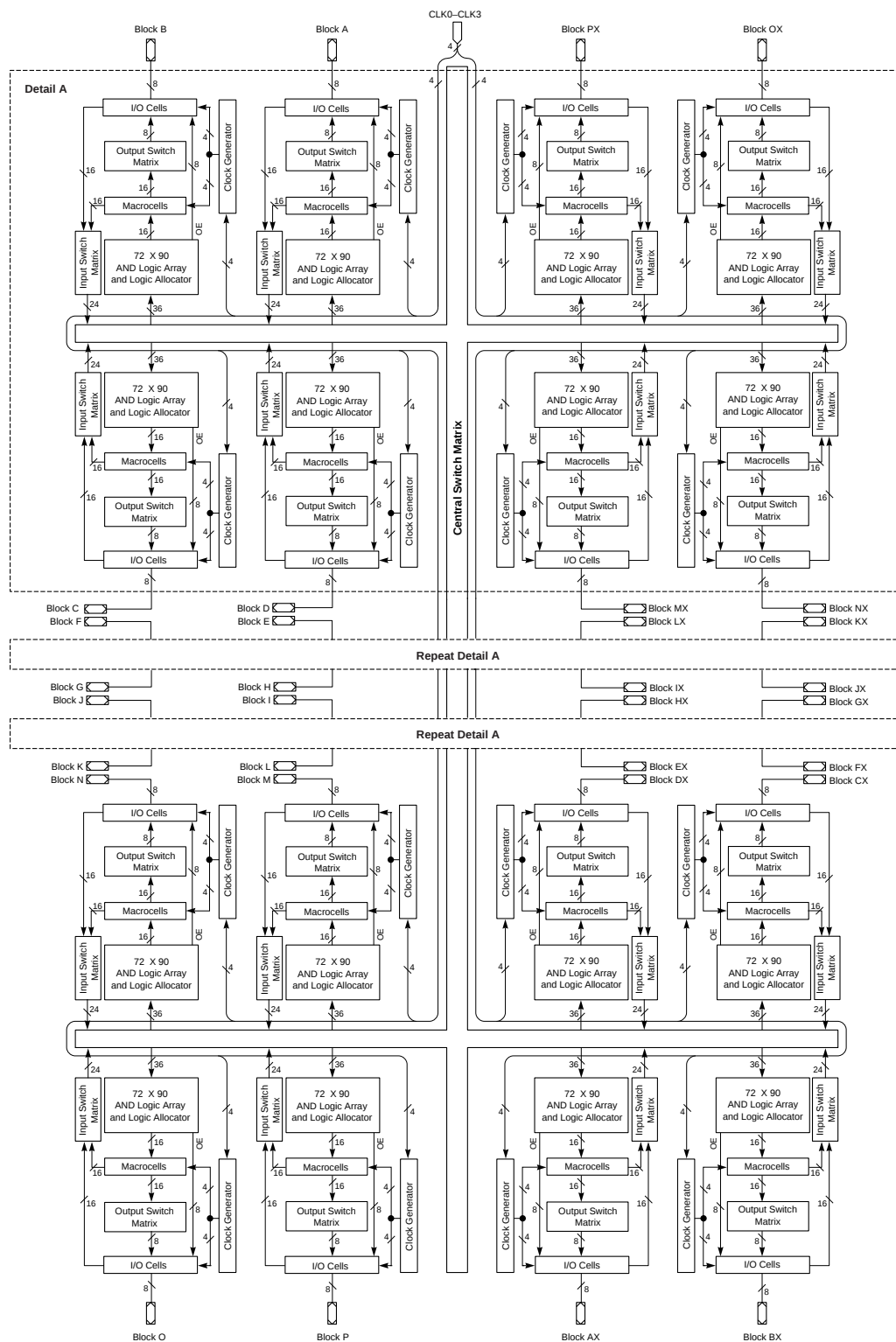
17466G-067

## BLOCK DIAGRAM – M4A3-384/160, M4A3-384/192



17466G-067

## BLOCK DIAGRAM - M4A3-512/160, M4A3-512/192, M4A3-512/256



17466G-068

## ABSOLUTE MAXIMUM RATINGS

### M4A5

Storage Temperature. . . . . -65°C to +150°C  
 Ambient Temperature  
 with Power Applied. . . . . -55°C to +100°C  
 Device Junction Temperature. . . . . +130°C  
 Supply Voltage  
 with Respect to Ground . . . . . -0.5 V to +7.0 V  
 DC Input Voltage . . . . . -0.5 V to  $V_{CC} + 0.5$  V  
 Static Discharge Voltage . . . . . 2000 V  
 Latchup Current ( $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ) . . . . . 200 mA

*Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability.*

## OPERATING RANGES

### Commercial (C) Devices

Ambient Temperature ( $T_A$ )  
 Operating in Free Air. . . . .  $0^\circ\text{C}$  to  $+70^\circ\text{C}$   
 Supply Voltage ( $V_{CC}$ )  
 with Respect to Ground. . . . . +4.75 V to +5.25 V

### Industrial (I) Devices

Ambient Temperature ( $T_A$ )  
 Operating in Free Air. . . . .  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$   
 Supply Voltage ( $V_{CC}$ )  
 with Respect to Ground. . . . . +4.50 V to +5.5 V  
*Operating ranges define those limits between which the functionality of the device is guaranteed.*

## 5-V DC CHARACTERISTICS OVER OPERATING RANGES

| Parameter Symbol | Parameter Description                 | Test Conditions                                                                       | Min | Typ | Max  | Unit          |
|------------------|---------------------------------------|---------------------------------------------------------------------------------------|-----|-----|------|---------------|
| $V_{OH}$         | Output HIGH Voltage                   | $I_{OH} = -3.2$ mA, $V_{CC} = \text{Min}$ , $V_{IN} = V_{IH}$ or $V_{IL}$             | 2.4 |     |      | V             |
|                  |                                       | $I_{OH} = -100$ $\mu\text{A}$ , $V_{CC} = \text{Max}$ , $V_{IN} = V_{IH}$ or $V_{IL}$ |     | 3.3 | 3.6  | V             |
| $V_{OL}$         | Output LOW Voltage                    | $I_{OL} = 24$ mA, $V_{CC} = \text{Min}$ , $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 1)      |     |     | 0.5  | V             |
| $V_{IH}$         | Input HIGH Voltage                    | Guaranteed Input Logical HIGH Voltage for all Inputs (Note 2)                         | 2.0 |     |      | V             |
| $V_{IL}$         | Input LOW Voltage                     | Guaranteed Input Logical LOW Voltage for all Inputs (Note 2)                          |     |     | 0.8  | V             |
| $I_{IH}$         | Input HIGH Leakage Current            | $V_{IN} = 5.25$ V, $V_{CC} = \text{Max}$ (Note 3)                                     |     |     | 10   | $\mu\text{A}$ |
| $I_{IL}$         | Input LOW Leakage Current             | $V_{IN} = 0$ V, $V_{CC} = \text{Max}$ (Note 3)                                        |     |     | -10  | $\mu\text{A}$ |
| $I_{OZH}$        | Off-State Output Leakage Current HIGH | $V_{OUT} = 5.25$ V, $V_{CC} = \text{Max}$ , $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 3)    |     |     | 10   | $\mu\text{A}$ |
| $I_{OZL}$        | Off-State Output Leakage Current LOW  | $V_{OUT} = 0$ V, $V_{CC} = \text{Max}$ , $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 3)       |     |     | -10  | $\mu\text{A}$ |
| $I_{SC}$         | Output Short-Circuit Current          | $V_{OUT} = 0.5$ V, $V_{CC} = \text{Max}$ (Note 4)                                     | -30 |     | -160 | mA            |

### Notes:

1. Total  $I_{OL}$  for one PAL block should not exceed 64 mA.
2. These are absolute values with respect to device ground, and all overshoots due to system or tester noise are included.
3. I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OZL}$  (or  $I_{IH}$  and  $I_{OZH}$ ).
4. Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.  
 $V_{OUT} = 0.5$  V has been chosen to avoid test problems caused by tester ground degradation.

## ispMACH 4A TIMING PARAMETERS OVER OPERATING RANGES<sup>1</sup>

|                   |                                                                                                                                                               | -5  |     | -55 |     | -6  |     | -65  |     | -7   |     | -10  |     | -12  |     | -14  |     | Unit |
|-------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|-----|-----|-----|------|-----|------|-----|------|-----|------|-----|------|-----|------|
|                   |                                                                                                                                                               | Min | Max | Min | Max | Min | Max | Min  | Max | Min  | Max | Min  | Max | Min  | Max | Min  | Max |      |
| Frequency:        |                                                                                                                                                               |     |     |     |     |     |     |      |     |      |     |      |     |      |     |      |     |      |
| f <sub>MAXS</sub> | External feedback, D-type, Min of 1/(t <sub>WLS</sub> + t <sub>WHS</sub> ) or 1/(t <sub>SS</sub> + t <sub>COS</sub> )                                         | 143 |     | 133 |     | 125 |     | 118  |     | 95.2 |     | 87.0 |     | 74.1 |     | 60.6 |     | MHz  |
|                   | External feedback, T-type, Min of 1/(t <sub>WLS</sub> + t <sub>WHS</sub> ) or 1/(t <sub>SST</sub> + t <sub>COS</sub> )                                        | 125 |     | 125 |     | 118 |     | 111  |     | 87.0 |     | 80.0 |     | 69.0 |     | 57.1 |     | MHz  |
|                   | Internal feedback (f <sub>CNT</sub> ), D-type, Min of 1/(t <sub>WLS</sub> + t <sub>WHS</sub> ) or 1/(t <sub>SS</sub> + t <sub>COSi</sub> )                    | 182 |     | 167 |     | 160 |     | 154  |     | 125  |     | 118  |     | 95.0 |     | 74.1 |     | MHz  |
|                   | Internal feedback (f <sub>CNT</sub> ), T-type, Min of 1/(t <sub>WLS</sub> + t <sub>WHS</sub> ) or 1/(t <sub>SST</sub> + t <sub>COSi</sub> )                   | 154 |     | 154 |     | 148 |     | 143  |     | 111  |     | 105  |     | 87.0 |     | 69.0 |     | MHz  |
|                   | No feedback <sup>2</sup> , Min of 1/(t <sub>WLS</sub> + t <sub>WHS</sub> ), 1/(t <sub>SS</sub> + t <sub>HS</sub> ) or 1/(t <sub>SST</sub> + t <sub>HS</sub> ) | 250 |     | 250 |     | 200 |     | 200  |     | 154  |     | 125  |     | 100  |     | 83.3 |     | MHz  |
| f <sub>MAXA</sub> | External feedback, D-type, Min of 1/(t <sub>WLA</sub> + t <sub>WHA</sub> ) or 1/(t <sub>SA</sub> + t <sub>COA</sub> )                                         | 111 |     | 111 |     | 108 |     | 100  |     | 83.3 |     | 66.7 |     | 55.6 |     | 43.5 |     | MHz  |
|                   | External feedback, T-type, Min of 1/(t <sub>WLA</sub> + t <sub>WHA</sub> ) or 1/(t <sub>SAT</sub> + t <sub>COA</sub> )                                        | 105 |     | 105 |     | 102 |     | 95.2 |     | 76.9 |     | 62.5 |     | 52.6 |     | 41.7 |     | MHz  |
|                   | Internal feedback (f <sub>CNTA</sub> ), D-type, Min of 1/(t <sub>WLA</sub> + t <sub>WHA</sub> ) or 1/(t <sub>SA</sub> + t <sub>COAi</sub> )                   | 133 |     | 133 |     | 125 |     | 125  |     | 105  |     | 83.3 |     | 66.7 |     | 50.0 |     | MHz  |
|                   | Internal feedback (f <sub>CNTA</sub> ), T-type, Min of 1/(t <sub>WLA</sub> + t <sub>WHA</sub> ) or 1/(t <sub>SAT</sub> + t <sub>COAi</sub> )                  | 125 |     | 125 |     | 125 |     | 118  |     | 95.2 |     | 76.9 |     | 62.5 |     | 47.6 |     | MHz  |
|                   | No feedback <sup>2</sup> , Min of 1/(t <sub>WLA</sub> + t <sub>WHA</sub> ), 1/(t <sub>SA</sub> + t <sub>HA</sub> ) or 1/(t <sub>SAT</sub> + t <sub>HA</sub> ) | 167 |     | 167 |     | 143 |     | 143  |     | 125  |     | 100  |     | 62.5 |     | 55.6 |     | MHz  |
| f <sub>MAXI</sub> | Maximum input register frequency, Min of 1/(t <sub>WIRH</sub> + t <sub>WIRL</sub> ) or 1/(t <sub>SIRS</sub> + t <sub>HIRS</sub> )                             | 167 |     | 167 |     | 143 |     | 143  |     | 125  |     | 100  |     | 83.3 |     | 83.3 |     | MHz  |

### Notes:

1. See "Switching Test Circuit" document on the Literature Download page of the Lattice web site.
2. This parameter does not apply to flip-flops in the emulated mode since the feedback path is required for emulation.

## CAPACITANCE<sup>1</sup>

| Parameter Symbol | Parameter Description | Test Conditions        |                           | Typ | Unit |
|------------------|-----------------------|------------------------|---------------------------|-----|------|
| $C_{IN}$         | Input capacitance     | $V_{IN}=2.0\text{ V}$  | 3.3 V or 5 V, 25°C, 1 MHz | 6   | pF   |
| $C_{I/O}$        | Output capacitance    | $V_{OUT}=2.0\text{ V}$ | 3.3 V or 5 V, 25°C, 1 MHz | 8   | pF   |

### Note:

1. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where this parameter may be affected.

## $I_{CC}$ vs. FREQUENCY

These curves represent the typical power consumption for a particular device at system frequency. The selected “typical” pattern is a 16-bit up-down counter. This pattern fills the device and exercises every macrocell. Maximum frequency shown uses internal feedback and a D-type register. Power/Speed are optimized to obtain the highest counter frequency and the lowest power. The highest frequency (LSBs) is placed in common PAL blocks, which are set to high power. The lowest frequency signals (MSBs) are placed in a common PAL block and set to lowest power.

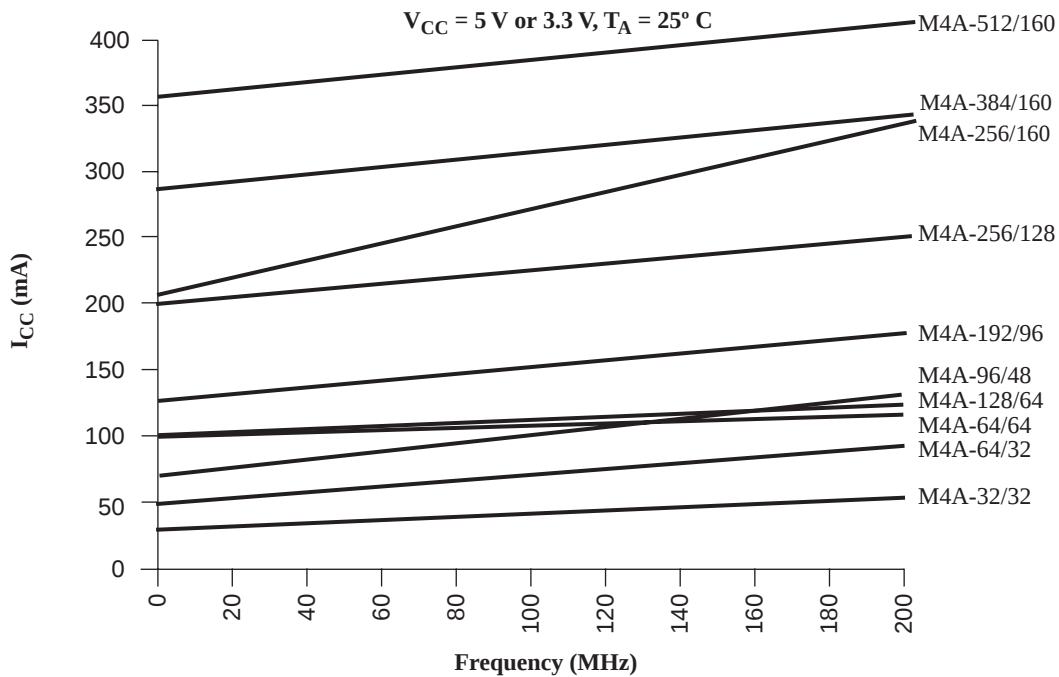


Figure 19. ispMACH 4A  $I_{CC}$  Curves at High Speed Mode

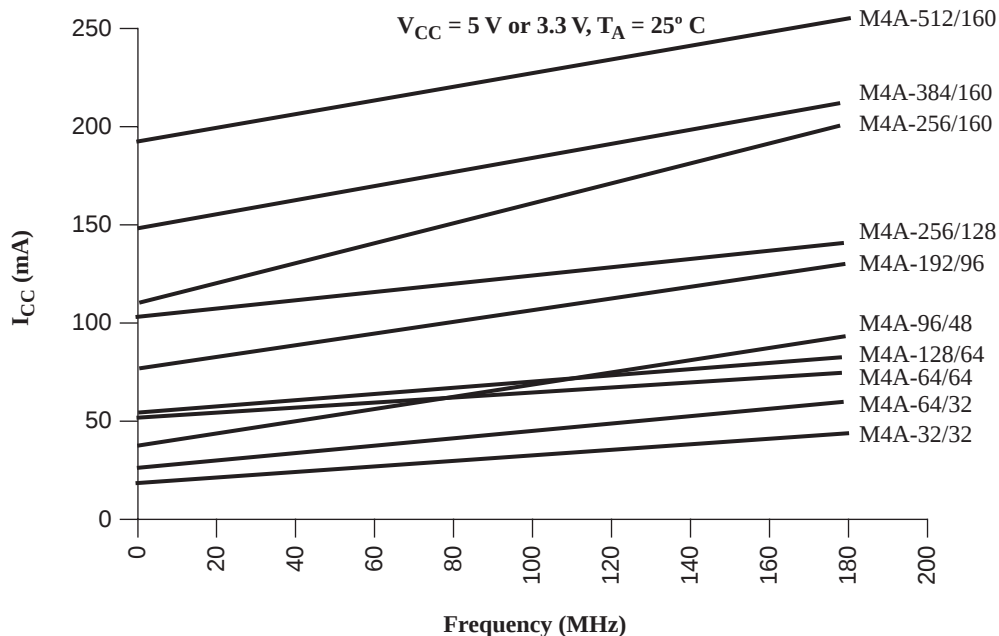


Figure 20. ispMACH 4A  $I_{CC}$  Curves at Low Power Mode

## 100-BALL caBGA CONNECTION DIAGRAM (M4A3-128/64)

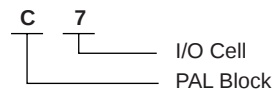
### Bottom View

100-Ball caBGA

|   | 10          | 9           | 8           | 7           | 6           | 5           | 4           | 3           | 2           | 1           |   |
|---|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|---|
| A | GND         | I/O63<br>H7 | I/O60<br>H4 | I/O57<br>H1 | GND         | GND         | I/O1<br>A1  | I/O4<br>A4  | I/O7<br>A7  | GND         | A |
| B | TRST        | GND         | I/O61<br>H5 | I5          | VCC         | I/O0<br>A0  | I/O6<br>A6  | GND         | TDI         | I/O15<br>B7 | B |
| C | I/O53<br>G5 | TDO         | I/O62<br>H6 | I/O58<br>H2 | I/O56<br>H0 | I/O2<br>A2  | GND         | I/O14<br>B6 | I/O13<br>B5 | I/O12<br>B4 | C |
| D | I/O50<br>G2 | I/O55<br>G7 | GND         | I/O59<br>H3 | I/O3<br>A3  | I/O5<br>A5  | I/O11<br>B3 | I/O10<br>B2 | CLK0/I0     | I/O9<br>B1  | D |
| E | CLK3/I4     | I/O49<br>G1 | I/O51<br>G3 | I/O54<br>G6 | VCC         | I/O16<br>C0 | I/O20<br>C4 | I/O8<br>B0  | VCC         | GND         | E |
| F | GND         | VCC         | I/O40<br>F0 | I/O52<br>G4 | I/O48<br>G0 | VCC         | I/O22<br>C6 | I/O19<br>C3 | I/O17<br>C1 | CLK1/I1     | F |
| G | I/O41<br>F1 | CLK2/I3     | I/O42<br>F2 | I/O43<br>F3 | I/O37<br>E5 | I/O35<br>E3 | I/O27<br>D3 | GND         | I/O23<br>C7 | I/O18<br>C2 | G |
| H | I/O44<br>F4 | I/O45<br>F5 | I/O46<br>F6 | GND         | I/O34<br>E2 | I/O24<br>D0 | I/O26<br>D2 | I/O30<br>D6 | TCK         | I/O21<br>C5 | H |
| J | I/O47<br>F7 | ENABLE      | GND         | I/O38<br>E6 | I/O32<br>E0 | VCC         | I2          | I/O29<br>D5 | GND         | TMS         | J |
| K | GND         | I/O39<br>E7 | I/O36<br>E4 | I/O33<br>E1 | GND         | GND         | I/O25<br>D1 | I/O28<br>D4 | I/O31<br>D7 | GND         | K |
|   | 10          | 9           | 8           | 7           | 6           | 5           | 4           | 3           | 2           | 1           |   |

#### PIN DESIGNATIONS

CLK = Clock  
 GND = Ground  
 I = Input  
 I/O = Input/Output  
 N/C = No Connect  
 VCC = Supply Voltage  
 TDI = Test Data In  
 TCK = Test Clock  
 TMS = Test Mode Select  
 TDO = Test Data Out  
 TRST = Test Reset  
 ENABLE = Program

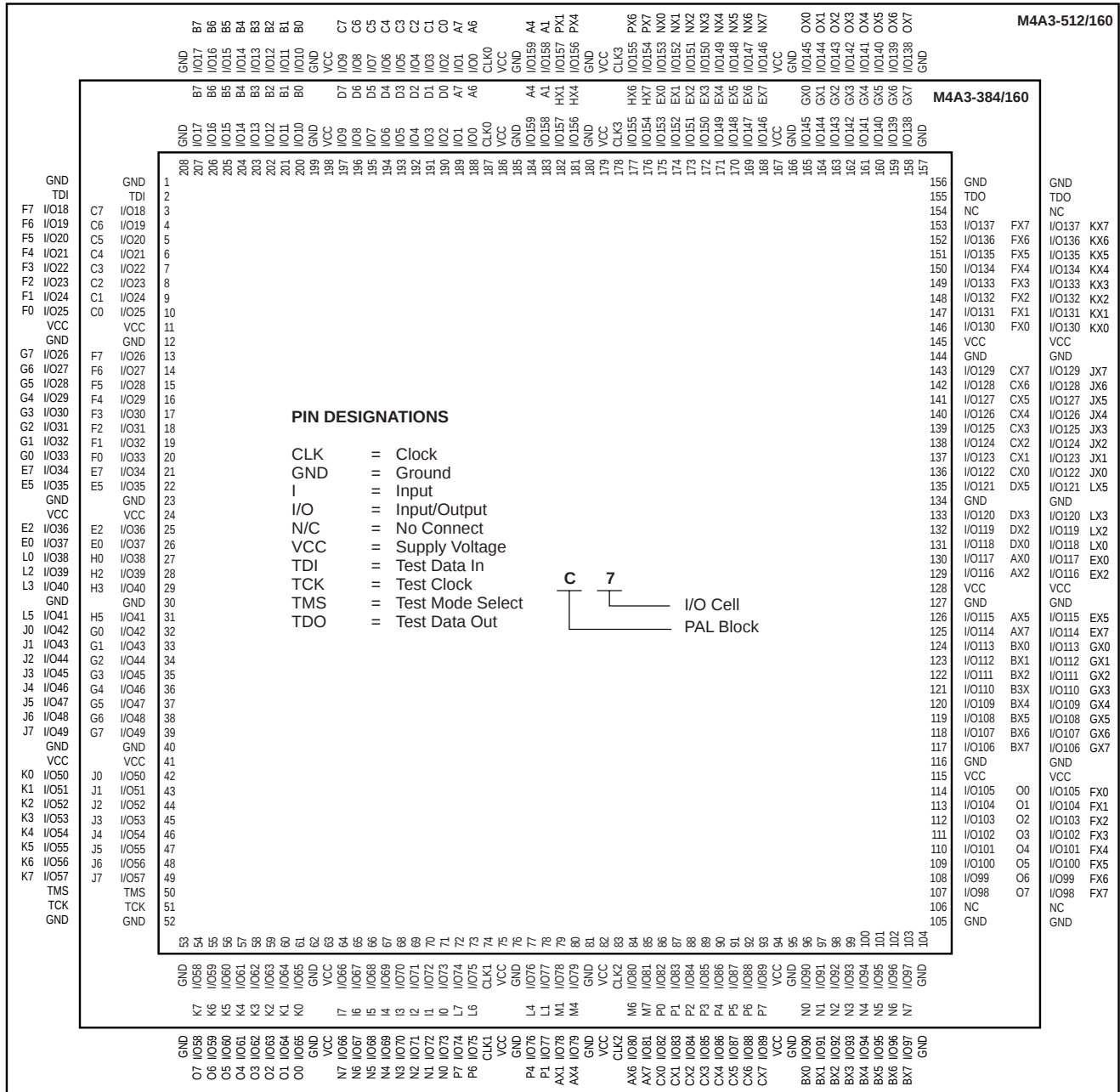


17466G-100cabga

# 208-PIN PQFP CONNECTION DIAGRAM (M4A3-384/160 AND M4A3-512/160)

## Top View

### 208-Pin PQFP



17466Ga-044

# 256-BALL fpBGA CONNECTION DIAGRAM (M4A3-384/192)

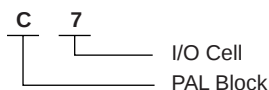
## Bottom View

### 256-Ball fpBGA

|   | 16            | 15            | 14            | 13            | 12            | 11            | 10            | 9             | 8             | 7           | 6           | 5           | 4           | 3           | 2           | 1           |   |
|---|---------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|---|
| A | I/O175<br>FX7 | I/O181<br>GX5 | I/O180<br>GX4 | I/O177<br>GX1 | I/O166<br>EX6 | I/O164<br>EX4 | I/O191<br>HX7 | I/O186<br>HX2 | I/O1<br>A1    | I/O3<br>A3  | CLK0        | I/O25<br>D1 | I/O29<br>D5 | I/O31<br>D7 | I/O10<br>B2 | I/O12<br>B4 | A |
| B | I/O173<br>FX5 | I/O174<br>FX6 | I/O182<br>GX6 | I/O179<br>GX3 | I/O167<br>EX7 | I/O165<br>EX5 | I/O160<br>EX0 | I/O187<br>HX3 | I/O0<br>A0    | I/O5<br>A5  | I/O7<br>A7  | I/O26<br>D2 | I/O8<br>B0  | I/O11<br>B3 | I/O13<br>B5 | N/C         | B |
| C | I/O171<br>FX3 | I/O172<br>FX4 | N/C           | I/O183<br>GX7 | I/O178<br>GX2 | I/O162<br>EX2 | I/O163<br>EX3 | I/O189<br>HX5 | I/O184<br>HX0 | I/O6<br>A6  | I/O28<br>D4 | I/O30<br>D6 | I/O15<br>B7 | I/O14<br>B6 | TDI         | I/O23<br>C7 | C |
| D | I/O150<br>CX6 | I/O151<br>CX7 | TDO           | GND           | GND           | VCC           | GND           | VCC           | GND           | GND         | VCC         | GND         | VCC         | I/O9<br>B1  | I/O22<br>C6 | I/O21<br>C5 | D |
| E | I/O148<br>CX4 | N/C           | I/O170<br>FX2 | VCC           | I/O168<br>FX0 | 169<br>FX1    | I/O190<br>HX6 | CLK3          | I/O188<br>HX4 | I/O2<br>A2  | I/O24<br>D0 | N/C         | GND         | I/O20<br>C4 | I/O19<br>C3 | I/O47<br>F7 | E |
| F | I/O144<br>CX0 | I/O149<br>CX5 | I/O147<br>CX3 | GND           | I/O146<br>CX2 | I/O145<br>CX1 | I/O176<br>GX0 | I/O161<br>EX1 | I/O185<br>HX1 | I/O4<br>A4  | I/O27<br>D3 | I/O18<br>C2 | VCC         | I/O16<br>C0 | I/O46<br>F6 | I/O45<br>F5 | F |
| G | I/O155<br>DX3 | I/O158<br>DX6 | I/O157<br>DX5 | VCC           | I/O156<br>DX4 | I/O159<br>DX7 | VCC           | GND           | GND           | VCC         | I/O17<br>C1 | I/O44<br>F4 | GND         | I/O42<br>F2 | I/O41<br>F1 | I/O39<br>E7 | G |
| H | I/O152<br>DX0 | I/O154<br>DX2 | I/O153<br>DX1 | GND           | I/O128<br>AX0 | I/O129<br>AX1 | GND           | VCC           | VCC           | GND         | I/O43<br>F3 | I/O40<br>F0 | VCC         | I/O36<br>E4 | I/O35<br>E3 | I/O34<br>E2 | H |
| J | I/O130<br>AX2 | I/O131<br>AX3 | I/O132<br>AX4 | GND           | I/O134<br>AX6 | I/O133<br>AX5 | GND           | VCC           | VCC           | GND         | I/O38<br>E6 | I/O37<br>E5 | GND         | I/O57<br>H1 | I/O56<br>H0 | I/O58<br>H2 | J |
| K | I/O135<br>AX7 | I/O136<br>BX0 | I/O137<br>BX1 | VCC           | I/O139<br>BX3 | I/O138<br>BX2 | VCC           | GND           | GND           | VCC         | I/O33<br>E1 | I/O32<br>E0 | VCC         | I/O63<br>H7 | I/O62<br>H6 | I/O48<br>G0 | K |
| L | I/O140<br>BX4 | I/O141<br>BX5 | I/O143<br>BX7 | GND           | I/O114<br>O2  | I/O142<br>BX6 | I/O98<br>M2   | I/O91<br>L3   | I/O67<br>I3   | I/O69<br>I5 | I/O60<br>H4 | I/O59<br>H3 | GND         | I/O51<br>G3 | I/O52<br>G4 | I/O49<br>G1 | L |
| M | I/O112<br>O0  | I/O113<br>O1  | I/O115<br>O3  | GND           | I/O123<br>P3  | I/O121<br>P1  | I/O100<br>M4  | I/O90<br>L2   | I/O66<br>I2   | I/O80<br>K0 | I/O83<br>K3 | I/O61<br>H5 | VCC         | I/O76<br>J4 | I/O55<br>G7 | I/O50<br>G2 | M |
| N | I/O116<br>O4  | I/O117<br>O5  | I/O119<br>O7  | VCC           | GND           | VCC           | GND           | VCC           | GND           | GND         | VCC         | GND         | GND         | TCK         | I/O72<br>J0 | I/O53<br>G5 | N |
| P | I/O118<br>O6  | I/O109<br>N5  | I/O110<br>N6  | I/O111<br>N7  | I/O124<br>P4  | I/O122<br>P2  | I/O101<br>M5  | I/O89<br>L1   | I/O93<br>L5   | I/O94<br>L6 | I/O71<br>I7 | I/O84<br>K4 | I/O87<br>K7 | TMS         | I/O73<br>J1 | I/O54<br>G6 | P |
| R | I/O108<br>N4  | I/O107<br>N3  | I/O104<br>N0  | I/O127<br>P7  | I/O120<br>P0  | I/O102<br>M6  | I/O99<br>M3   | I/O96<br>M0   | I/O92<br>L4   | I/O64<br>I0 | I/O68<br>I4 | I/O81<br>K1 | I/O85<br>K5 | I/O79<br>J7 | I/O75<br>J3 | I/O74<br>J2 | R |
| T | I/O106<br>N2  | I/O105<br>N1  | I/O126<br>P6  | I/O125<br>P5  | I/O103<br>M7  | CLK2          | I/O97<br>M1   | I/O88<br>L0   | CLK1          | I/O95<br>L7 | I/O65<br>I1 | I/O70<br>I6 | I/O82<br>K2 | I/O86<br>K6 | I/O78<br>J6 | I/O77<br>J5 | T |
|   | 16            | 15            | 14            | 13            | 12            | 11            | 10            | 9             | 8             | 7           | 6           | 5           | 4           | 3           | 2           | 1           |   |

### PIN DESIGNATIONS

CLK = Clock  
 GND = Ground  
 I = Input  
 I/O = Input/Output  
 N/C = No Connect  
 VCC = Supply Voltage  
 TDI = Test Data In  
 TCK = Test Clock  
 TMS = Test Mode Select  
 TDO = Test Data Out



m4a3.384.192\_256bga

| 5V Commercial Combinations |              |              |
|----------------------------|--------------|--------------|
| M4A5-32/32                 | -5, -7, -10, | JC, VC, VC48 |
| M4A5-64/32                 | -55, -7, -10 | JC, VC, VC48 |
| M4A5-96/48                 |              | VC           |
| M4A5-128/64                |              | YC, VC       |
| M4A5-192/96                | -6, -7, -10  | VC           |
| M4A5-256/128               | -65, -7, -10 | YC           |

| 5V Industrial Combinations |              |              |
|----------------------------|--------------|--------------|
| M4A5-32/32                 | -7, -10, -12 | JJ, VI, VI48 |
| M4A5-64/32                 | -7, -10, -12 | JJ, VI, VI48 |
| M4A5-96/48                 |              | VI           |
| M4A5-128/64                |              | YI, VI       |
| M4A5-192/96                | -7, -10, -12 | VI           |
| M4A5-256/128               | -10, -12     | YI           |

## Lead-free Packaging

| 3.3V Commercial Combinations |               |                 |
|------------------------------|---------------|-----------------|
| M4A3-32/32                   | -5, -7, -10   | VNC, VNC48, JNC |
| M4A3-64/32                   | -55, -7, -10  | VNC, VNC48, JNC |
| M4A3-64/64                   |               | VNC             |
| M4A3-128/64                  |               | VNC             |
| M4A3-192/96                  | -6, -7, -10   | VNC             |
| M4A3-256/128                 | -55, -7, -10  | FANC, YNC       |
| M4A3-256/160                 | -7, -10       | YNC             |
| M4A3-256/192                 |               | FANC            |
| M4A3-384/192                 | -65, -10, -12 | FANC            |
| M4A3-512/192                 | -7, -10, -12  | FANC            |

| 3.3V Industrial Combinations |               |                 |
|------------------------------|---------------|-----------------|
| M4A3-32/32                   | -7, -10, -12  | VNI, VNI48, JNI |
| M4A3-64/32                   |               | VNI, VNI48, JNI |
| M4A3-64/64                   |               | VNI             |
| M4A3-128/64                  |               | VNI             |
| M4A3-192/96                  | -10, -12      | VNI             |
| M4A3-256/128                 |               | FANI, YNI       |
| M4A3-256/160                 |               | YNI             |
| M4A3-256/192                 | -10, -12, -14 | FANI            |
| M4A3-384/192                 |               | FANI            |
| M4A3-512/192                 |               | FANI            |

| 5V Commercial Combinations |              |                 |
|----------------------------|--------------|-----------------|
| M4A5-32/32                 | -5, -7, -10  | VNC, VNC48, JNC |
| M4A5-64/32                 | -55, -7, -10 | VNC, VNC48, JNC |
| M4A5-96/48                 |              | VNC             |
| M4A5-128/64                |              | VNC, YNC        |
| M4A5-192/96                | -6, -7, -10  | VNC             |
| M4A5-256/128               | -65, -7, -10 | YNC             |

| 5V Industrial Combinations |              |                 |
|----------------------------|--------------|-----------------|
| M4A5-32/32                 | -7, -10, -12 | VNI, VNI48, JNI |
| M4A5-64/32                 |              | VNI, VNI48, JNI |
| M4A5-96/48                 |              | VNI             |
| M4A5-128/64                |              | VNI, YNI        |
| M4A5-192/96                |              | VNI             |
| M4A5-256/128               |              | YNI             |

Most ispMACH devices are dual-marked with both Commercial and Industrial grades. The Industrial speed grade is slower, i.e., M4A3-256/128-7YC-10YI

### Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local Lattice sales office to confirm availability of specific valid combinations and to check on newly released combinations.